

els extra low shrinkage[®] unibond

Technical Data

Product description	HEMA- and TEGDMA-free, lightcuring 1-Component Self-Etch-Adhesive.
Composition base	Ethanol, Water, ethoxylated BisGMA, Phosphoric acid methacrylate, Initiators
Consistency	low viscous
Shear bond strength	25.6 MPa (self etch; 24 h, 37 °C human- dentine) ¹⁾ 15.4 MPa (self etch; 3d, 37 °C, 500 TC*, human-dentine) ¹⁾ 34,2 MPa (etch & rinse, 24 h, 37 °C, human-dentine) ¹⁾ 32.9 MPa (etch & rinse, 3d, 37 °C, 500 TC*, human-dentine) ¹⁾ 15.1 MPa (self etch; 24 h, 37 °C, human enamel) ¹⁾ 14.0 MPa (self etch; 3d, 37 °C, 500 TC*, human enamel) ¹⁾ 27.8 MPa (etch & rinse, 24 h, 37 °C, human enamel) ¹⁾ 20.2 MPa (etch & rinse, 3d, 37 °C, 500 TC*, human enamel) ¹⁾

*TC = Thermocycling



¹⁾ Abschlussbericht Gutachten Scherhafttest Universalbond Fa. Saremco, Uwe Blunck, Charité –
Universitätsmedizin Berlin, 05 2016.

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